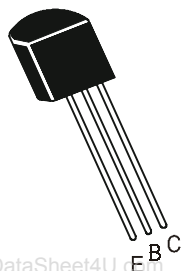


PNP/NPN EPITAXIAL PLANAR SILICON TRANSISTORS

CSA709 PNP
CSC1009 NPN
TO-92
CBE



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High Voltage Amplifier.

ABSOLUTE MAXIMUM RATINGS(Ta=25deg C)

DESCRIPTION	SYMBOL	CSA709	CSC1009	UNIT
Collector -Base Voltage	VCBO	160	160	V
Collector -Emitter Voltage	VCEO	150	140	V
Emitter -Base Voltage	VEBO	8.0	8.0	V
Collector Current	IC	700	700	mA
Collector Dissipation	PC	800	800	mW
Operating And Storage Junction Temperature Range	Tj, Tstg	-55 to +150	-55 to +150	deg C

ELECTRICAL CHARACTERISTICS (Ta=25 deg C Unless Otherwise Specified)

DESCRIPTION	SYMBOL	TEST CONDITION	CSA709	CSC1009	UNIT
Collector -Base Voltage	VCBO	IC=100uA, IE=0	>160	>160	V
Collector -Emitter Voltage	VCEO	IC=10mA, IB=0	>150	>140	V
Emitter-Base Voltage	VEBO	IE=100uA, IC=0	>8.0	>8.0	V
Collector-Cut off Current	ICBO	VCB=60V, IE=0	-	<100	nA
		VCB=100V, IE=0	<100	-	nA
Emitter-Cut off Current	IEBO	VEB=5V, IC=0	<100	<100	nA
DC Current Gain	hFE*	IC=50mA, VCE=2V	40-400	40-400	
Collector Emitter Saturation Voltage	VCE(Sat)*	IC=200mA, IB=20mA	<0.4	<0.7	V
Base Emitter Saturation Voltage	VBE(Sat) *	IC=200mA, IB=20mA	<1.1	<1.1	V

DYNAMIC CHARACTERISTICS

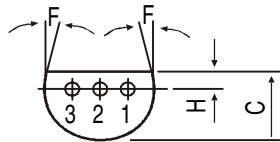
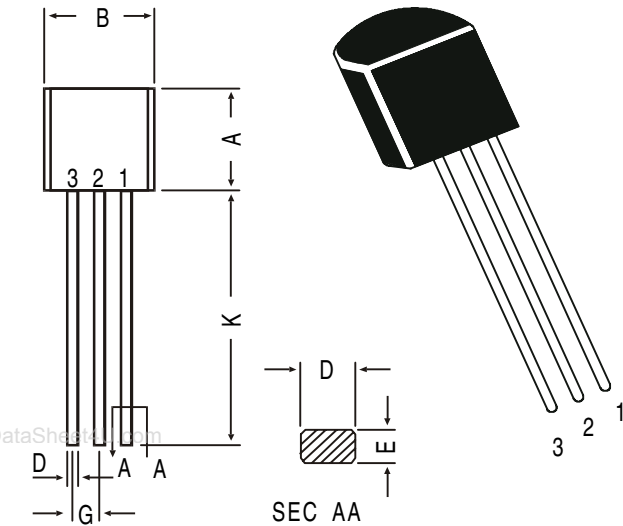
Transition Frequency	ft	IC=50mA, VCE=10V	typ50	>30	MHz
Out-Put Capacitance	Cob	VCB=10V, IE=0 f=1MHz	<10	typ8.0	pF

*hFE CLASSIFICATION	CSC1009	R : 40 - 80	O : 70 -140	Y : 120-240	G: 200-400
	CSA709	-	O : 70 -140	Y : 120-240	G: 200-400

*Pulse Test: PW=350us, Duty Cycle=2%

TO-92 Plastic Package

TO-92 Transistors on Tape and Ammo Pack

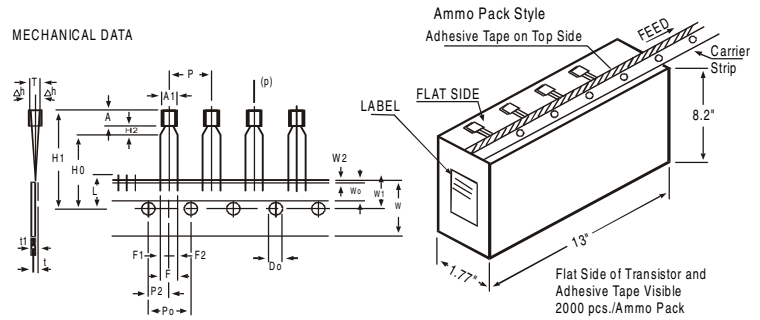


PIN CONFIGURATION

1. COLLECTOR
2. BASE
3. EMITTER

All dimensions in mm.

DIM	MIN.	MAX.
A	4.32	5.33
B	4.45	5.20
C	3.18	4.19
D	0.41	0.55
E	0.35	0.50
F	5 DEG	
G	1.14	1.40
H	1.14	1.53
K	12.70	—



All dimensions in mm unless specified otherwise

ITEM	SYMBOL	SPECIFICATION				REMARKS
		MIN.	NOM.	MAX.	TOL.	
BODY WIDTH	A1	4.0		4.8		
BODY HEIGHT	A	4.8		5.2		
BODY THICKNESS	T	3.9		4.2		
PITCH OF COMPONENT	P		12.7		±1	
FEED HOLE PITCH	Po		12.7		±0.3	CUMULATIVE PITCH ERROR 1.0 mm/20 PITCH
FEED HOLE CENTRE TO COMPONENT CENTRE	P2		6.35		±0.4	TO BE MEASURED AT BOTTOM OF CLINCH
DISTANCE BETWEEN OUTER LEADS	F		5.08		+0.6 -0.2	
COMPONENT ALIGNMENT	△h		0	1		AT TOP OF BODY
TAPE WIDTH	W		18		±0.5	
HOLD-DOWN TAPE WIDTH	Wo		6		±0.2	
HOLE POSITION	W1		9		+0.7 -0.5	
HOLD-DOWN TAPE POSITION	W2		0.5		±0.2	
LEAD WIRE CLINCH HEIGHT	Ho		16		±0.5	
COMPONENT HEIGHT	H1			23.25		
LENGTH OF SNIPPED LEADS	L			11.0		
FEED HOLE DIAMETER	Do		4		±0.2	
TOTAL TAPE THICKNESS	t			1.2		t1 0.3 - 0.6
LEAD - TO - LEAD DISTANCEF1,	F2		2.54		+0.4 -0.1	
CLINCH HEIGHT	H2			3		
PULL - OUT FORCE	(P)	6N				

NOTES

1. MAXIMUM ALIGNMENT DEVIATION BETWEEN LEADS NOT TO BE GREATER THAN 0.2 mm.
2. MAXIMUM NON-CUMULATIVE VARIATION BETWEEN TAPE FEED HOLES SHALL NOT EXCEED 1 mm IN 20 PITCHES.
3. HOLDDOWN TAPE NOT TO EXCEED BEYOND THE EDGE(S) OF CARRIER TAPE AND THERE SHALL BE NO EXPOSURE OF ADHESIVE.
4. NO MORE THAN 3 CONSECUTIVE MISSING COMPONENTS ARE PERMITTED.
5. A TAPE TRAILER, HAVING AT LEAST THREE FEED HOLES ARE REQUIRED AFTER THE LAST COMPONENT.
6. SPLICES SHALL NOT INTERFERE WITH THE SPROCKET FEED HOLES.

Packing Detail

PACKAGE	STANDARD PACK		INNER CARTON BOX		OUTER CARTON BOX		
	Details	Net Weight/Qty	Size	Qty	Size	Qty	Gr Wt
TO-92 Bulk	1K/polybag	200 gm/1K pcs	3" x 7.5" x 7.5"	5.0K	17" x 15" x 13.5"	80.0K	23 kgs
TO-92 T&A	2K/ammo box	645 gm/2K pcs	12.5" x 8" x 1.8"	2.0K	17" x 15" x 13.5"	32.0K	12.5 kgs

Customer Notes

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